

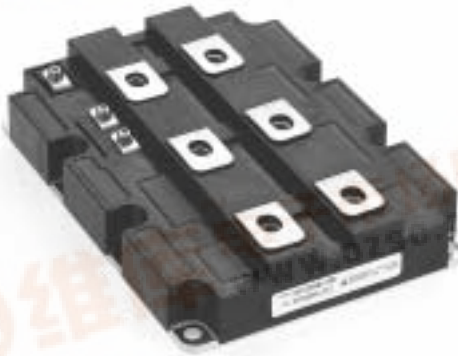
MITSUBISHI HVIGBT MODULES

CM1200HC-50H

HIGH POWER SWITCHING USE
INSULATED TYPE

HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

CM1200HC-50H



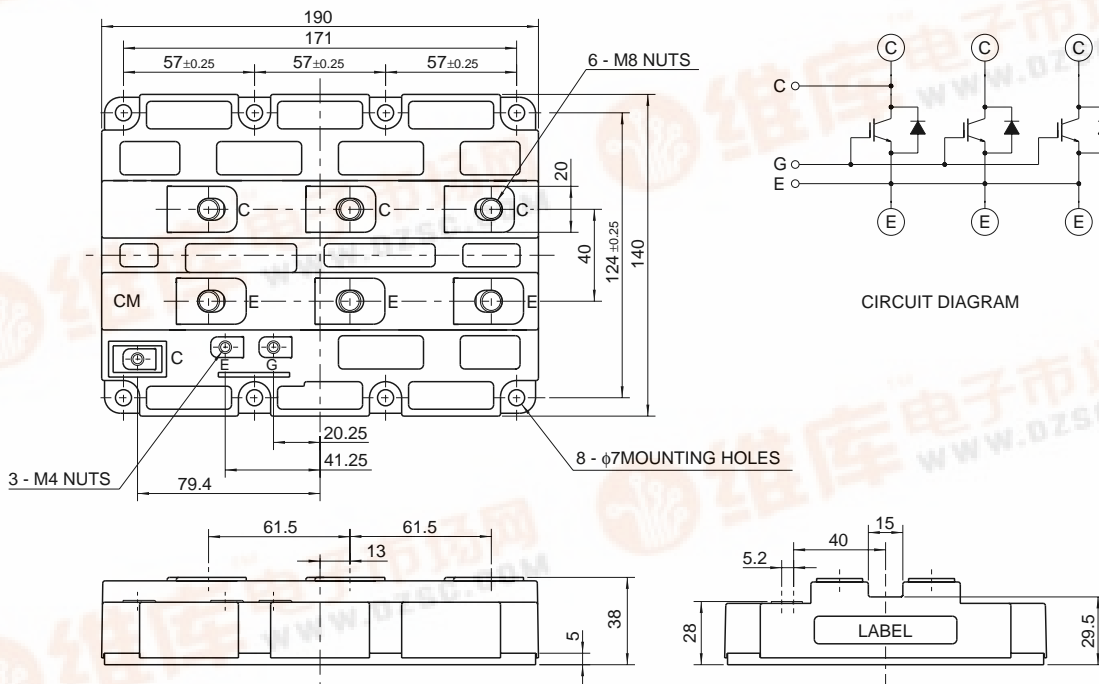
- Ic 1200A
- VCES 2500V
- Insulated Type
- 1-element in a pack

APPLICATION

Inverters, Converters, DC choppers, Induction heating, DC to DC converters.

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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MAXIMUM RATINGS (T_j = 25°C)

Symbol	Item	Conditions	Ratings	Unit
V _{CES}	Collector-emitter voltage	V _{GE} = 0V	2500	V
V _{GES}	Gate-emitter voltage	V _{CE} = 0V	±20	V
I _C	Collector current	T _C = 25°C	1200	A
I _{CM}		Pulse (Note 1)	2400	A
I _E (Note 2)	Emitter current	T _C = 25°C	1200	A
I _{EM} (Note 2)		Pulse (Note 1)	2400	A
P _C (Note 3)	Maximum collector dissipation	T _C = 25°C, IGBT part	15600	W
T _j	Junction temperature	—	-40 ~ +150	°C
T _{stg}	Storage temperature	—	-40 ~ +125	°C
V _{iso}	Isolation voltage	Charged part to base plate, rms, sinusoidal, AC 60Hz 1min.	6000	V
—	Mounting torque	Main terminals screw M8	6.67 ~ 13.00	N·m
		Mounting screw M6	2.84 ~ 6.00	N·m
		Auxiliary terminals screw M4	0.88 ~ 2.00	N·m
—	Mass	Typical value	2.2	kg

ELECTRICAL CHARACTERISTICS (T_j = 25°C)

Symbol	Item	Conditions	Limits			Unit	
			Min	Typ	Max		
I _{CES}	Collector cutoff current	V _{CE} = V _{CES} , V _{GE} = 0V	—	—	15	mA	
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 120mA, V _{CE} = 10V	4.5	6.0	7.5	V	
I _{GES}	Gate-leakage current	V _{GE} = V _{GES} , V _{CE} = 0V	—	—	0.5	μA	
V _{CE(sat)}	Collector-emitter saturation voltage	T _j = 25°C	I _C = 1200A, V _{GE} = 15V (Note 4)	—	2.80	3.64	V
		T _j = 125°C		—	3.15	—	
C _{ies}	Input capacitance	V _{CE} = 10V V _{GE} = 0V	—	180	—	nF	
C _{oes}	Output capacitance		—	13.5	—	nF	
C _{res}	Reverse transfer capacitance		—	6.0	—	nF	
Q _G	Total gate charge	V _{CC} = 1250V, I _C = 1200A, V _{GE} = 15V	—	8.1	—	μC	
t _{d(on)}	Turn-on delay time	V _{CC} = 1250V, I _C = 1200A	—	—	1.60	μs	
t _r	Turn-on rise time	V _{GE1} = V _{GE2} = 15V	—	—	2.00	μs	
t _{d(off)}	Turn-off delay time	R _G = 1.6Ω	—	—	2.50	μs	
t _f	Turn-off fall time	Resistive load switching operation	—	—	1.00	μs	
V _{EC} (Note 2)	Emitter-collector voltage	I _E = 1200A, V _{GE} = 0V	—	2.50	3.25	V	
t _{rr} (Note 2)	Reverse recovery time	I _E = 1200A,	—	—	1.20	μs	
Q _{rr} (Note 2)	Reverse recovery charge	die / dt = -2400A / μs (Note 1)	—	350	—	μC	
R _{th(j-c)Q}	Thermal resistance	Junction to case, IGBT part	—	—	0.010	K/W	
R _{th(j-c)R}		Junction to case, FWDi part	—	—	0.020	K/W	
R _{th(c-f)}	Contact thermal resistance	Case to fin, conductive grease applied	—	0.008	—	K/W	

Note 1. Pulse width and repetition rate should be such that the device junction temp. (T_j) does not exceed T_{jmax} rating.

2. I_E, V_{EC}, t_{rr}, Q_{rr} & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.

3. Junction temperature (T_j) should not increase beyond 150°C.

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

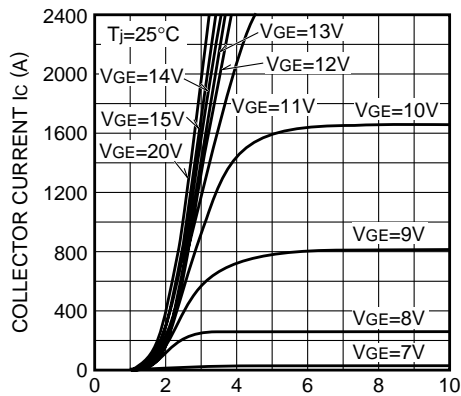
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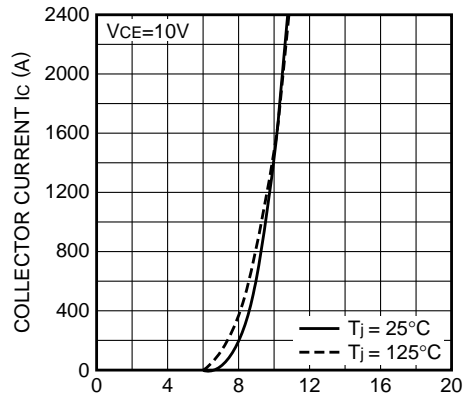
PERFORMANCE CURVES

OUTPUT CHARACTERISTICS (TYPICAL)



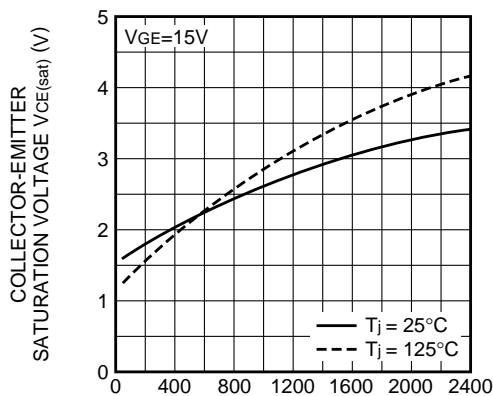
COLLECTOR-EMITTER SATURATION VOLTAGE $V_{CE(sat)}$ (V)

TRANSFER CHARACTERISTICS (TYPICAL)



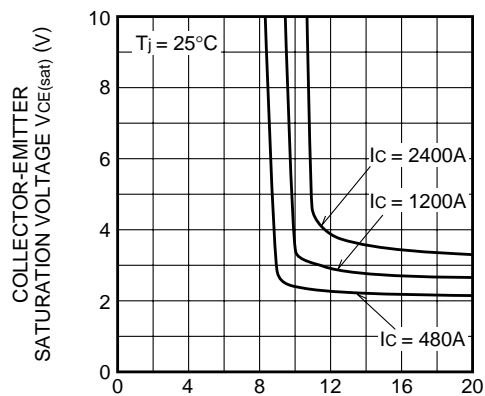
GATE-EMITTER VOLTAGE V_{GE} (V)

COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



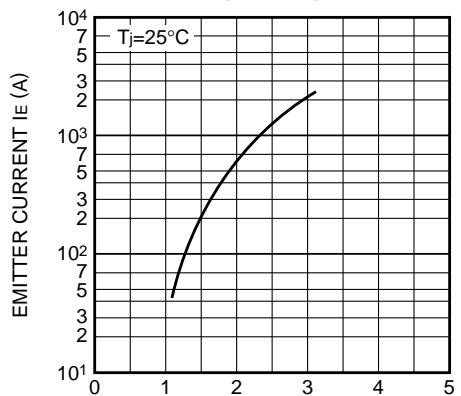
COLLECTOR CURRENT I_c (A)

COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



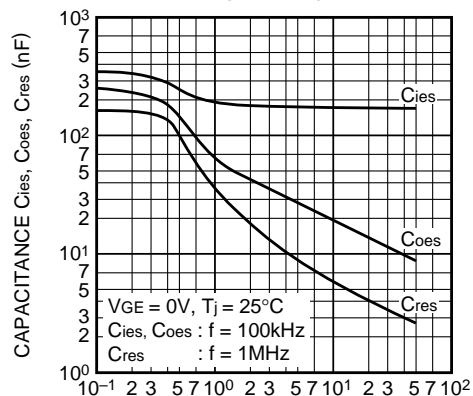
GATE-EMITTER VOLTAGE V_{GE} (V)

FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



EMITTER-COLLECTOR VOLTAGE V_{EC} (V)

CAPACITANCE VS. V_{CE} (TYPICAL)



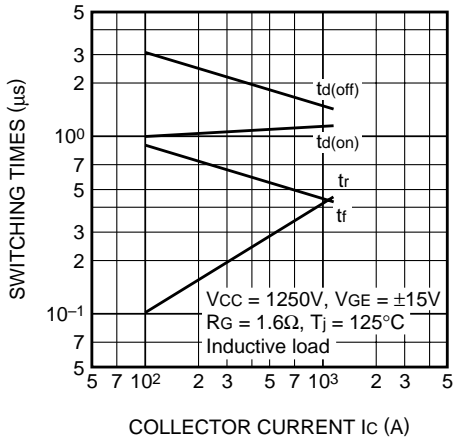
COLLECTOR-EMITTER VOLTAGE V_{CE} (V)

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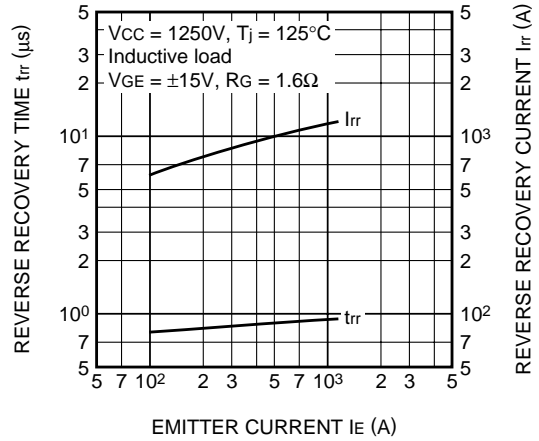
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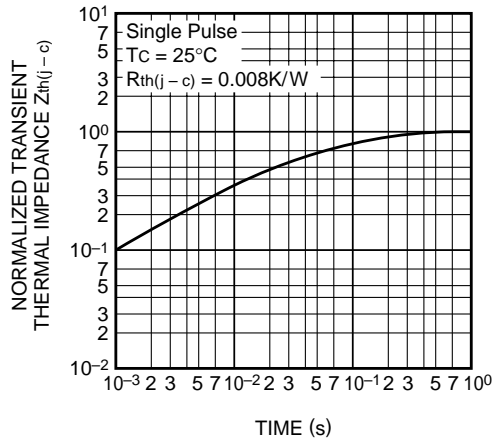
**HALF-BRIDGE
SWITCHING CHARACTERISTICS
(TYPICAL)**



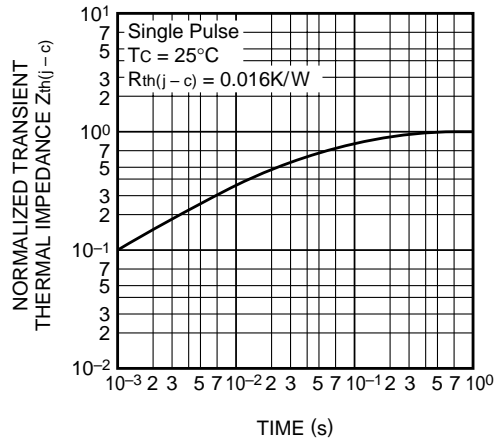
**REVERSE RECOVERY CHARACTERISTICS
OF FREE-WHEEL DIODE
(TYPICAL)**



**TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(IGBT part)**



**TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(FWDi part)**



**VGE - GATE CHARGE
(TYPICAL)**

